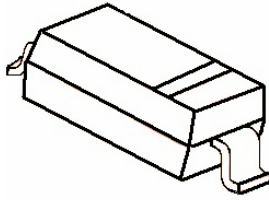


SOD-323

SOD-323 Plastic-Encapsulate Zener Diode



特征 Features

- 齐纳击穿阻抗低; Low Zener Impedance
- 最大功率耗散 200mW; Power Dissipation of 200mW
- 高稳定性和可靠性。High Stability and High Reliability

机械数据 Mechanical Data

- 封装: SOD-323 封装 SOD-323 Small Outline Plastic Package
- 极性: 色环端为负极 Polarity: Color band denotes cathode end
- 环氧树脂 UL 易燃等级 Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

极限值和温度特性(TA = 25℃ 除非另有规定)

Maximum Ratings & Thermal Characteristics (Ratings at 25℃ ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
功率消耗 Power Dissipation	Pd	200 ¹⁾	mW
正向压降 Forward Voltage @IF=10mA	Vf	0.9 ²⁾	V
存储温度 Storage temperature range	Ts	-65-+150	℃

1) Device mounted on ceramic PCB: 7.6mm x 9.4mm x 0.87mm with pad areas 25mm²

2) Short duration test pulse used to minimize self-heating effect

3) f=1KHz

电特性 (TA = 25℃ 除非另有规定)

Electrical Characteristics (Ratings at 25℃ ambient temperature unless otherwise specified.)

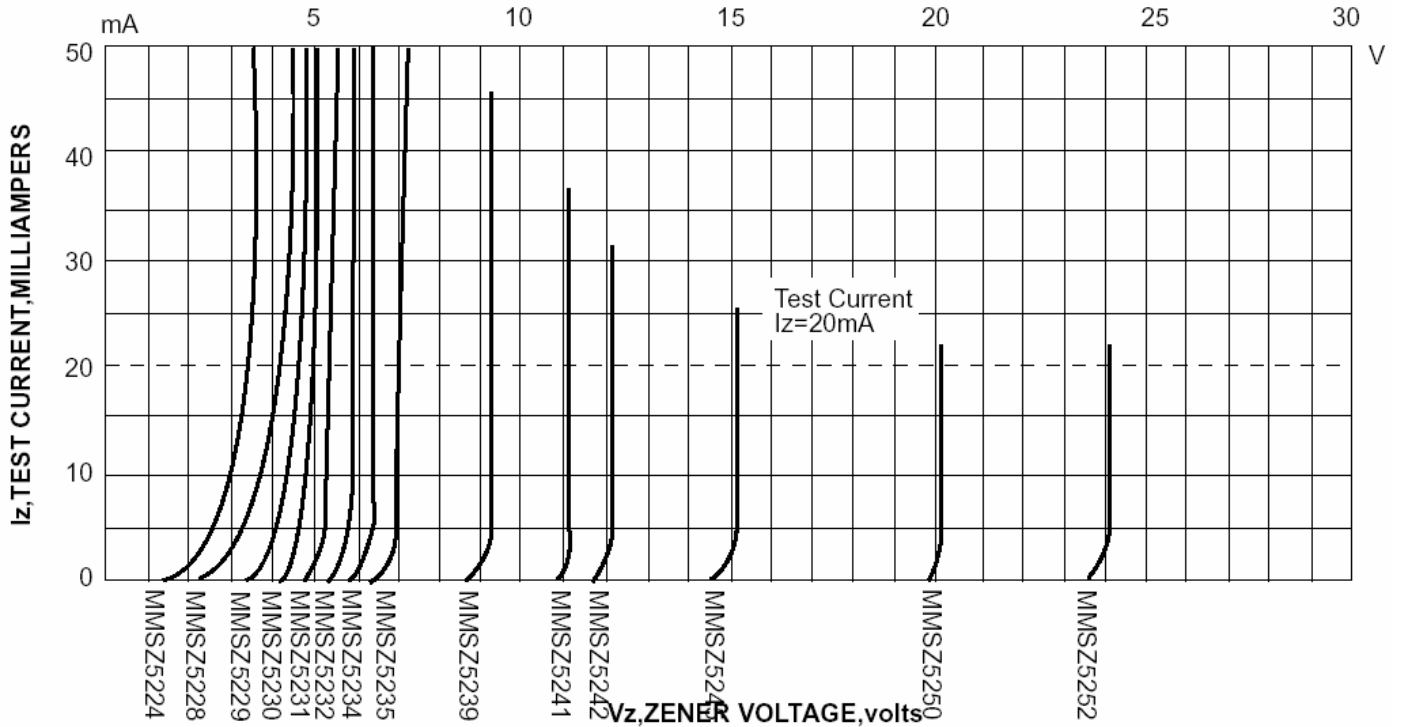
型号	印字 (代码)	Vz1(@Izt)				Zzt@Izt	Zzk		IR	
		Min (V)	Nom (V)	Max (V)	Izt mA	Max Ω	Max Ω	Izk mA	Max uA	VR V
MMSZ5221BS	C1	2.28	2.4	2.52	20	30	1200	0.25	100	1.0
MMSZ5223BS	C3	2.57	2.7	2.84	20	30	1300	0.25	75	1.0
MMSZ5225BS	C5	2.85	3.0	3.15	20	30	1600	0.25	50	1.0
MMSZ5226BS	G1	3.14	3.3	3.47	20	28	1600	0.25	25	1.0
MMSZ5227BS	G2	3.42	3.6	3.78	20	24	1700	0.25	15	1.0
MMSZ5228BS	G3	3.71	3.9	4.10	20	23	1900	0.25	10	1.0
MMSZ5229BS	G4	4.09	4.3	4.52	20	22	2000	0.25	5.0	1.0
MMSZ5230BS	G5	4.47	4.7	4.94	20	19	1900	0.25	5.0	2.0
MMSZ5231BS	E1	4.85	5.1	5.36	20	17	1600	0.25	5.0	2.0
MMSZ5232BS	E2	5.32	5.6	5.88	20	11	1600	0.25	5.0	3.0
MMSZ5233BS	E3	5.70	6.0	6.30	20	7	1600	0.25	5.0	3.5
MMSZ5234BS	E4	5.89	6.2	6.51	20	7	1000	0.25	5.0	4.0
MMSZ5235BS	E5	6.46	6.8	7.14	20	5	750	0.25	3	5.0
MMSZ5236BS	F1	7.13	7.5	7.88	20	6	500	0.25	3	6.0
MMSZ5237BS	F2	7.79	8.2	8.61	20	8	500	0.25	3	6.5
MMSZ5238BS	F3	8.27	8.7	9.14	20	8	600	0.25	3	6.5
MMSZ5239BS	F4	8.65	9.1	9.56	20	10	600	0.25	3	7.0

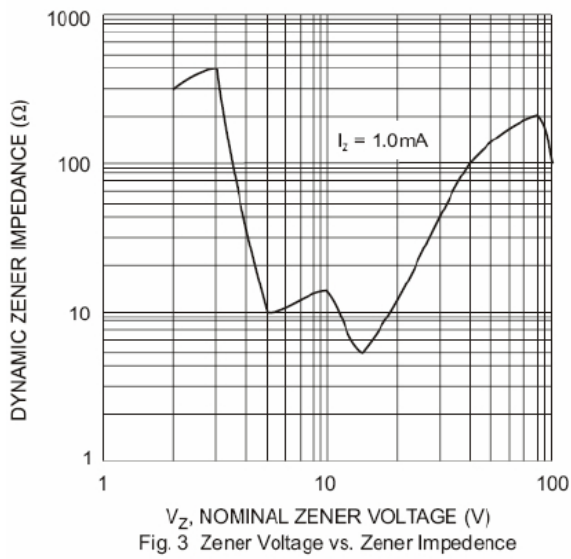
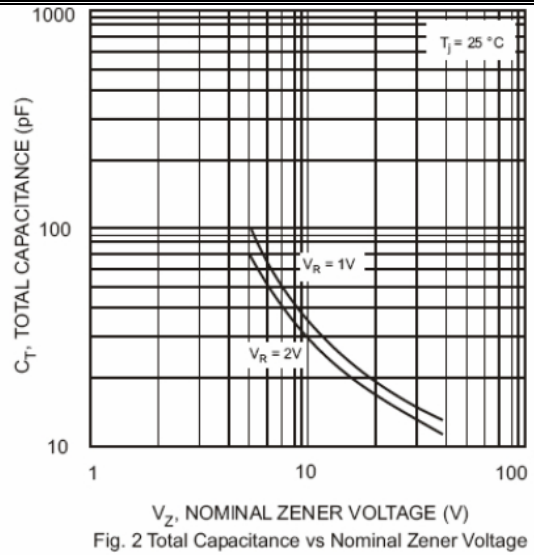
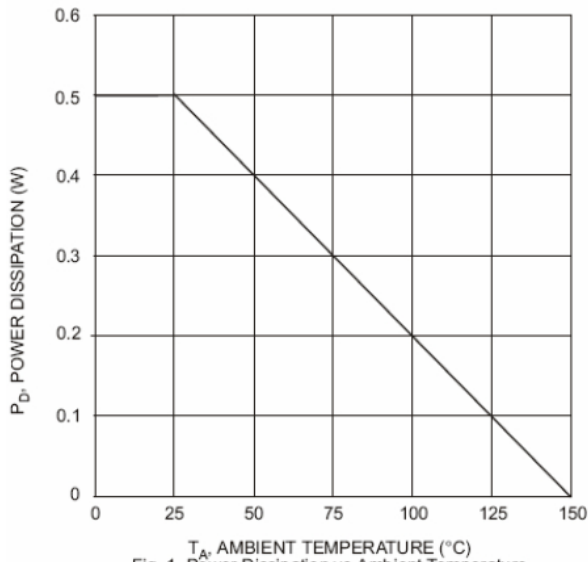
MMSZ5221BS- MMSZ 5259BS Series

型号	印字 (代码)	Vz1(@Izt)				Zzt@Izt	Zzk		IR	
		Min (V)	Nom (V)	Max (V)	Izt mA	Max Ω	Max Ω	Izk mA	Max uA	VR V
MMSZ5241BS	H1	10.45	11	11.55	20	22	600	0.25	2.0	8.4
MMSZ5242BS	H2	11.40	12	12.60	20	30	600	0.25	1.0	9.1
MMSZ5243BS	H3	12.35	13	13.65	9.5	13	600	0.25	0.5	9.9
MMSZ5244BS	H4	13.30	14	14.70	9.0	15	600	0.25	0.1	10
MMSZ5245BS	H5	14.25	15	15.75	8.5	16	600	0.25	0.1	11
MMSZ5246BS	J1	15.20	16	16.80	7.8	17	600	0.25	0.1	12
MMSZ5248BS	J3	17.10	18	18.90	7.0	21	600	0.25	0.1	14
MMSZ5250BS	J5	19.00	20	21.00	6.2	25	600	0.25	0.1	15
MMSZ5251BS	K1	20.90	22	23.10	5.6	29	600	0.25	0.1	17
MMSZ5252BS	K2	22.80	24	25.20	5.2	33	600	0.25	0.1	18
MMSZ5253BS	K3	23.75	25	26.25	5.0	35	600	0.25	0.1	19
MMSZ5254BS	K4	25.65	27	28.35	5.0	41	600	0.25	0.1	21
MMSZ5255BS	K5	26.60	28	29.40	4.5	44	600	0.25	0.1	21
MMSZ5256BS	M1	28.50	30	31.50	4.2	49	600	0.25	0.1	23
MMSZ5257BS	M2	31.35	33	34.65	3.8	58	700	0.25	0.1	25
MMSZ5258BS	M3	34.20	36	37.80	3.4	70	700	0.25	0.1	27
MMSZ5259BS	M4	37.05	39	40.95	3.2	80	800	0.25	0.1	30

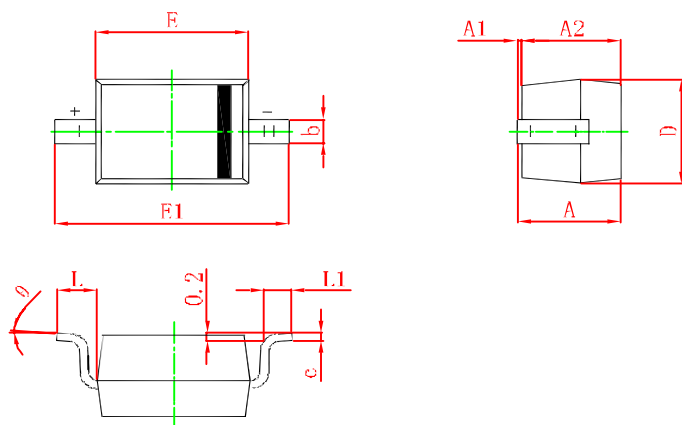
VF≤0.9V@IF=10mA

Breakdown characteristics





SOD-323 PACKAGE OUTLINE Plastic surface mounted package
SOD-323



Symbol	Min.(mm)	Max.(mm)
A		1.000
A1	0.000	0.100
A2	0.800	0.900
b	0.250	0.350
c	0.080	0.150
D	1.200	1.400
E	1.600	1.800
E1	2.500	2.700
L	0.475REF	
L1	0.250	0.400
θ	0°	8°